

PRELIMINARY DATA SHEET

SKY65126: 800–900 MHz High Linearity 2 W Power Amplifier

Applications

- WCDMA/CDMA/TDMA/GSM/LTE
- Repeaters
- · WLL and ISM band transmitter
- Mobile radios
- · Femto cell base stations

Features

- High linearity: OIP3 > 52 dBm
- $P_{1 dB} > 32.5 dBm$
- ACLR = -45 dBc for $P_{OUT} > 25$ dBm
- EVM < 3% for $P_{OUT} > 25$ dBm (OFDM, 64-QAM)
- High efficiency: PAE 33%
- High gain: 31.5 dB
- Internal RF match and bias circuits
- Single DC supply: 5 V
- MCM (20-pin, 6 x 6 mm) lead (Pb)-free package (MSL-3 @ 260 °C per JEDEC J-STD-020)

Description

The SKY65126 is a fully matched 20-pin, lead-free, surface mount, Multichip Module (MCM) Power Amplifier (PA) designed for WCDMA/CDMA/TDMA/GSM/LTE radio, repeaters, transmitters, mobile radios and Femto cell base station applications operating in the 800–900 MHz bandwidth.

All active circuitry in the module is contained in a single Gallium Arsenide (GaAs) Microwave Monolithic Integrated Circuit (MMIC).

The device is manufactured with Skyworks Aluminum (Al) GaAs Heterojunction Bipolar Transistor (HBT) process, which allows for single supply operation while maintaining high efficiency and good linearity.

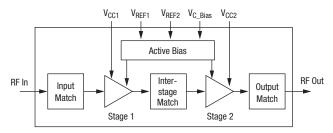
The module can operate over the temperature range of -40 °C to +85 °C. A populated evaluation board is available upon request.



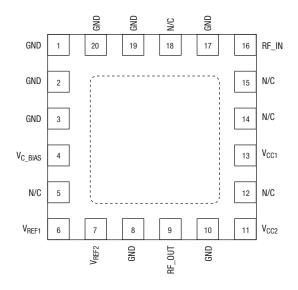
Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.

Preliminary Data Sheet: Based on engineering results. Sampling quantities available. Pin out and package have been determined.

Block Diagram



Package Diagram



Electrical Specifications

V_{CC1} , V_{CC2} , V_{REF1} , V_{REF2} , $V_{C_BIAS} = 5$ V, Frequency = 850 MHz, $T_c = 25$ °C, unless otherwise specified

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Frequency	F		800		900	MHz
Gain	IS ₂₁ I	Small signal	30	31.5		dB
Input return loss	IS ₁₁ I	Small signal		10.4		dB
Output return loss	IS ₂₂ I	Small signal		18.3		dB
Output power @ P _{1 dB}	P _{1 dB}	CW		32.5		dBm
Output 3rd order intercept	OIP3	P _{OUT} /tone = 19 dBm, tone spacing= 1 MHz	43	52		dBm
Noise figure	NF	CW		4.3	7	dB
ACLR1 @ P _{OUT} = 25 dBm	ACLR1	WCDMA test tone #1: 64 DPCH, ∆F = 5 MHz		-45	-45	dBc
ACLR2 @ P _{OUT} = 21 dBm	ACLR2	WCDMA test tone #1: 64 DPCH, △F = 10 MHz		-67	-55	dBc
Power-added efficiency	PAE	CW, P _{OUT} @ P _{1 dB}		33		%
Quiescent current	I _{CCQ}	No RF signal		271		mA

Absolute Maximum Ratings

Characteristic	Value		
RF input power	0 dBm		
Supply voltage (V _{CC} , V _{C_BIAS} , V _{REF})	6 V		
Operating case temperature (T _C)	-40 °C to +85 °C		
Storage temperature (T _{ST})	-55 °C to +125 °C		
Junction temperature (T _J)	150 °C		

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty. Each absolute maximum rating listed is an individual parameter. Biasing and driving the amplifier with more than one absolute maximum rating listed may result in permanent damage to the device. Exposure to maximum rating conditions for extended periods may reduce device reliability.

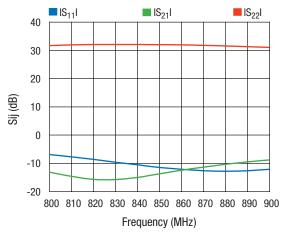
CAUTION: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be employed at all times.

Recommended Operating Conditions

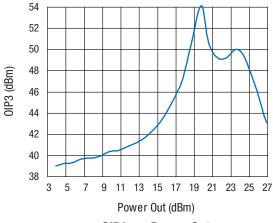
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply voltage	V _{CC} , V _{REF} , V _{C_BIAS}			5		V
Operating frequency	F ₀		800		900	MHz
Operating case temperature	T _C		-40	+25	+85	°C

Typical Performance Data

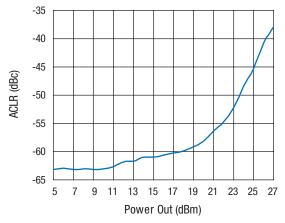
 V_{CC1} , V_{CC2} , V_{REF1} , V_{REF2} , $V_{C_BIAS} = 5$ V, Frequency = 850 MHz, $T_{c} = 25$ °C, unless otherwise specified.



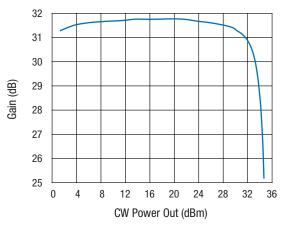
S-Parameters vs. Frequency



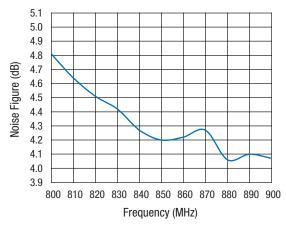
OIP3 vs. Power Out Tone Spacing = 1 MHz



ACLR vs. Power Out (WCDMA Test Tone #1, 64 DPCH $\Delta F = 5$ MHz)



Gain vs. Power Out



Noise Figure vs. Frequency

Theory of Operation

The SKY65126 is comprised of two amplifier stages. The matching circuits for the input stage, inter-stage, and output stage are contained within the device. An on-chip active bias circuit is included within the device for both input and output stages providing for excellent gain tracking over temperature and voltage variations.

The SKY65126 is internally matched for optimum linearity and efficiency. The input and output stages are independently supplied using the VCC1 and VCC2 supply lines, pins 13 and 11, respectively. The bias reference voltages for stages 1 and 2 are supplied using common lines VREF1 and VREF2 (pins 6 and 7) line. The DC control voltage that sets the bias to stages 1 and 2 is supplied via VC_BIAS, pin 4.

Application Circuit Notes

Center Ground. It is extremely important that the device paddle be sufficiently grounded for both thermal and stability reasons. Multiple small vias are acceptable and will work well under th edevice if solder migration is an issue.

Ground (Pins 1, 2, 3, 8, 10, 17, 19, 20). Attach all ground pins to the RF ground plane with the largest diameter and lowest inductance via that the layout will allow. Multiple small vias are also acceptable and will work well under the device if solder migration is an issue.

No Connect (Pins 5, 12, 14, 15, 18). The pins are open and may or may not be connected to ground.

 V_{C_BIAS} (Pin 4). V_{C_BIAS} is the bias supply voltage for stages 1 and 2. Typically set to 5 V.

 V_{REF1} (Pin 6). Bias reference voltage for amplifier stage 1. V_{REF1} should be operated over the same voltage range as V_{CC} , with a nominal voltage of 5 V.

 V_{REF2} (Pin 7). Bias reference voltage for amplifier stage 2. V_{REF1} should be operated over the same voltage range as V_{CC} , with a nominal voltage of 5 V.

RF_OUT (Pin 9). Amplifier RF Output Pin. $Z_0=50~\Omega$. The module includes an onboard internal DC blocking capacitor. All impedance matching is provided internal to the module.

 V_{CC2} (Pin 11). Supply voltage for the output (final) stage collector bias (typically 5 V). Bypassing of V_{CC2} is accomplished with C10, C11 and C12 and should be placed in the approximate location shown on the evaluation board, but placement is not critical.

 V_{CC1} (Pin 13). Supply voltage for the first stage collector bias (typically 5 V). Bypassing of V_{CC1} is accomplished with C6, C7 and C8 and should be placed in the approximate location shown on the evaluation board, but placement is not critical.

RF_IN (**Pin 16**). Amplifier RF Input Pin. $Z_0 = 50~\Omega$. The module includes an onboard internal DC blocking capacitor. All impedance matching is provided internal to the module.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

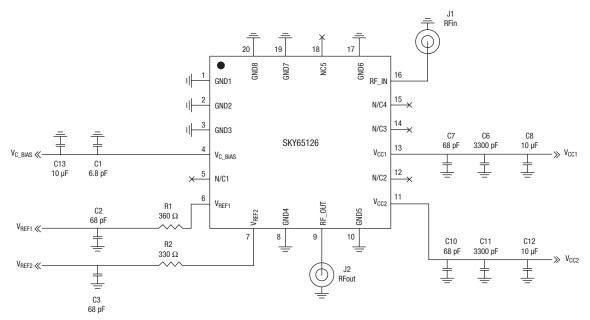
Please refer to Skyworks' *Solder Reflow* application note, available at www.skyworksinc.com, for instructions on mounting the SKY65126 to a printed circuit board.

Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks *Tape and Reel* application note, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

The SKY65126 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

Application Circuit



Pin Assignments

Pin	Pin Name	Description		
1	GND	Low inductance ground connection		
2	GND	Low inductance ground connection		
3	GND	Low inductance ground connection		
4	V _{C_BIAS}	Bias voltage		
5	N/C	No connect		
6	V _{REF1}	Bias reference voltage 1		
7	V _{REF2}	Bias reference voltage 2		
8	GND	Low inductance ground connection		
9	RF_OUT	RF output		
10	GND	Low inductance ground connection		
11	V _{CC2}	Stage 2 collector voltage		
12	N/C	No connect		
13	V _{CC1}	Stage 1 collector voltage		
14	N/C	No connect		
15	N/C	No connect		
16	RF_IN	RF input		
17	GND	Low inductance ground connection		
18	N/C	No connect		
19	GND	Low inductance ground connection		
20	GND	Low inductance ground connection		

Center attachment pad must have a low inductance and low thermal resistance connection to the customer's printed circuit board ground plane.

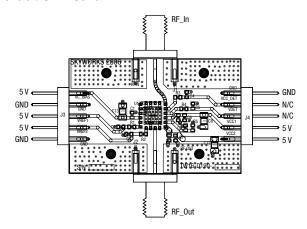
Evaluation Board Description

The Skyworks SKY65126 Evaluation Board is used to test the performance of the SKY65126 power amplifier module. The following design considerations are general in nature and must be followed regardless of final use or configuration.

- 1. Paths to ground should be made as short as possible.
- 2. The ground pad of the SKY65126 power amplifier module has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the amplifiers. As such, design the connection to the ground pad to dissipate the maximum wattage produced to the circuit. Multiple vias to the grounding layer are required.

NOTE: Junction temperature (T_J) of the device increases with a poor connection to the slug and ground. This reduces the lifetime of the device.

Evaluation Board



Evaluation Board Test Procedure

- Step 1. Connect RF test equipment to amplifier input/output SMA connectors.
- Step 2. Connect DC ground.
- Step 3. Connect all V_{CC} , V_{REG} and V_{C_BIAS} lines to 5 V supply. Verify the I_{CCQ} current is approximately 271 mA.
- Step 4. Apply RF signal data -20 dBm level and observe that the output level is approximately 11.5 dBm or the gain of the device is approximately 31.5 dB.

NOTE: It is important that the V_{CC1} and V_{CC2} voltage source be adjusted such that 5 V is measured at the board. The high collector currents will drop the collector voltage significantly if long leads are used. Adjust the bias voltage to compensate.

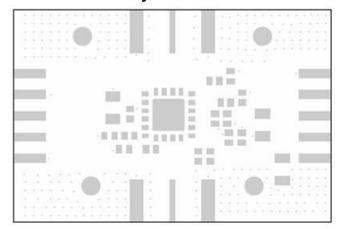
Recommended Solder Reflow Profiles

Refer to the "<u>Recommended Solder Reflow Profile</u>" Application Note.

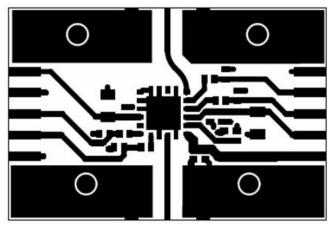
Tape and Reel Information

Refer to the "<u>Discrete Devices and IC Switch/Attenuators</u> Tape and Reel Package Orientation" Application Note.

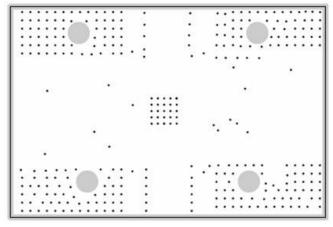
Evaluation Board Layer Detail



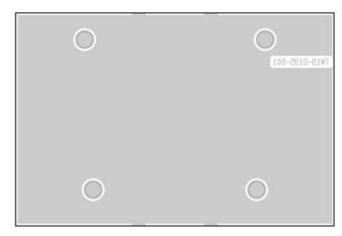
Layer 1: Solder Mask



Layer 1: Top Metal



Layer 2 and 3: Ground

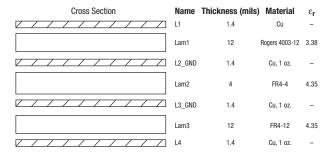


Layer 4: Solid Ground Plane

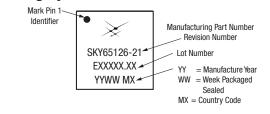
Bill of Material for Evaluation Board

Part	ID	QTY	Size	Value	Units	Product Number	Manufacturer	Manufacturer's Part Number	Characteristics
1	C1	1	0603	3300	pF	SK204-000-007	Murata	GRM188R71H332KA01D	X7R, 50 V, ± 10%
2	C2	1	0603	68	pF	5404R23-023	Murata	GRM1885C1H680JA01D	COG, 50 V, ± 5%
3	C3	1	0603	68	pF	5404R23-023	Murata	GRM1885C1H680JA01D	COG, 50 V, ± 5%
4	C6	1	0603	3300	pF	SK204-000-007	Murata	GRM188R71H332KA01D	X7R, 50 V, ± 10%
5	C7	1	0603	68	pF	5404R23-023	Murata	GRM1885C1H680JA01D	COG, 50 V, ± 5%
6	C8	1	1206	10	μF	5404R91-005	TDK	C3216X5R0J106KT	X5R, 6 V, ± 10%
7	C10	1	0603	68	pF	5404R23-023	Murata	GRM1885C1H680JA01D	COG, 50 V, ± 5%
8	C11	1	0603	3300	pF	SK204-000-007	Murata	GRM188R71H332KA01D	X7R, 50 V, ± 10%
9	C12	1	1206	10	μF	5404R91-005	TDK	C3216X5R0J106KT	X5R, 6 V, ± 10%
10	C13	1	1206	10	μF	5404R91-005	TDK	C3216X5R0J106KT	X5R, 6 V, ± 10%
11	R1	1	0603	360	Ω	5424R20-038	Rohm	MCR03EZHUJ360	50 V, 0.063W, ± 5%
12	R2	1	0603	330	Ω	5424R20-037	Rohm	MCR03EZHUF330	50 V, 0.063W, ± 5%

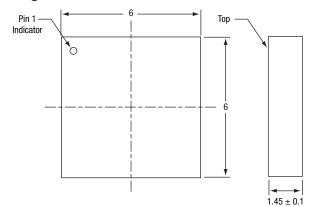
Evaluation Board Stack-Up

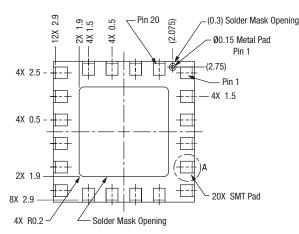


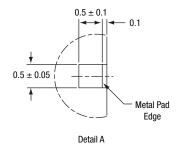
Branding Specifications



Package Dimensions

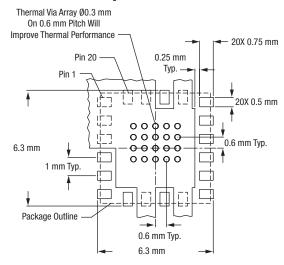




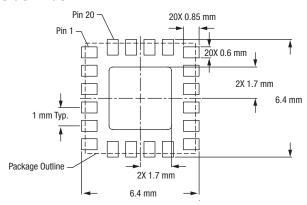


All dimensions are in millimeters Dimensioning and tolerancing according to ASME Y14.5M-1994

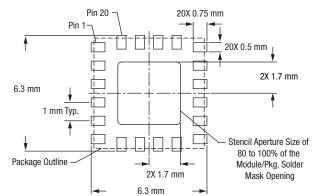
Recommended Footprint



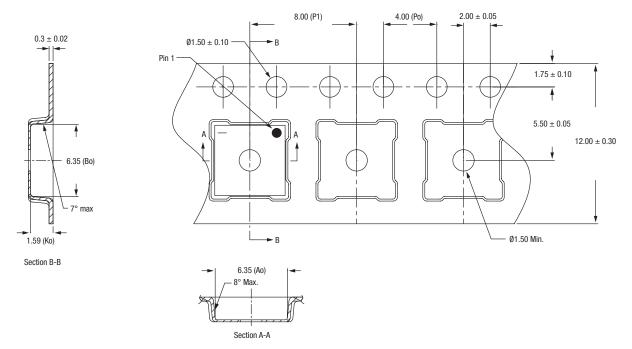
Solder Mask



Stencil Pattern



Tape and Reel Dimensions



- Carrier tape: black conductive polystyrene
 Cover tape material: transparent conductive PSA
 Cover tape size: 9.3 mm width
- 4. All dimensions are in millimeters

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Kit Part Number	
SKY65126: 800–900 MHz High Linearity 2 W Power Amplifier	SKY65126-21 (Pb-free package)	TW17-D500-001	

Copyright $\ @$ 2008, 2009, Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks, the Skyworks symbol, and "Breakthrough Simplicity" are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.